

LME49722 Low Noise, High Performance, High Fidelity Dual Audio Operational Amplifier

Check for Samples: [LME49722](#)

FEATURES

- Easily Drives 600Ω Loads
- Optimized for Superior Audio Signal Fidelity
- Output Short Circuit Protection
- PSRR and CMRR Exceed 120dB (typ)

APPLICATIONS

- Ultra High Quality Audio Amplification
- High Fidelity Preamplifiers, Phono Preamps, and Multimedia
- High Performance Professional Audio
- High Fidelity Equalization and Crossover Networks with Active Filters
- High Performance Line Drivers and Receivers
- Low Noise Industrial Applications Including Test, Measurement, and Ultrasound

DESCRIPTION

The LME49722 is part of the ultra-low distortion, low noise, high slew rate operational amplifier series optimized and fully specified for high performance, high fidelity applications. Combining advanced leading-edge process technology with state-of-the-art circuit design, the LME49722 audio operational amplifiers deliver superior audio signal amplification for outstanding audio performance. The LME49722 combines extremely low voltage noise density (1.9nV/√Hz) rate with vanishingly low THD+N (0.00002%) to easily satisfy the most demanding audio applications. To ensure that the most challenging loads are driven without compromise, the LME49722 has a high slew rate of ±22V/μs and an output current capability of ±28mA. Further, dynamic range is maximized by an output stage that drives 2kΩ loads to within 1V of either power supply voltage.

The LME49722 has a wide supply range of ±2.5V to ±18V. Over this supply range the LME49722 maintains excellent common-mode and power supply rejection, and low input bias current. This Audio Operational Amplifier achieves outstanding AC performance while driving complex loads with values as high as 100pF with gain value greater than 2. Directly interchangeable with LME49720, LM4562 and LME49860 for similar operating voltages.

Table 1. KEY SPECIFICATIONS

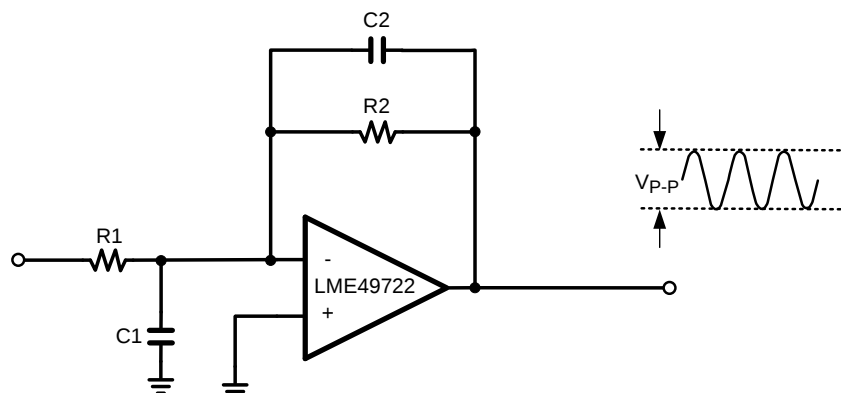
		VALUE	UNIT
Wide Operating Voltage Range		±2.5V to ±18	V
Equivalent Noise	(Frequency = 1kHz)	1.9	nV/√Hz (typ)
Equivalent Noise	(Frequency = 10Hz)	2.8	nV/√Hz (typ)
PSRR		120	dB (typ)
Slew Rate		±22	V/μs (typ)
THD+N (A _V = 1, V _{OUT} = 3V _{RMS} , f _{IN} = 1kHz)	R _L = 2kΩ	0.00002	% (typ)
	R _L = 600Ω	0.00002	% (typ)
Open Loop Gain (R _L = 600Ω)		135	dB (typ)
Input Bias Current		50	nA (typ)
Voltage Offset		±0.02	mV (typ)



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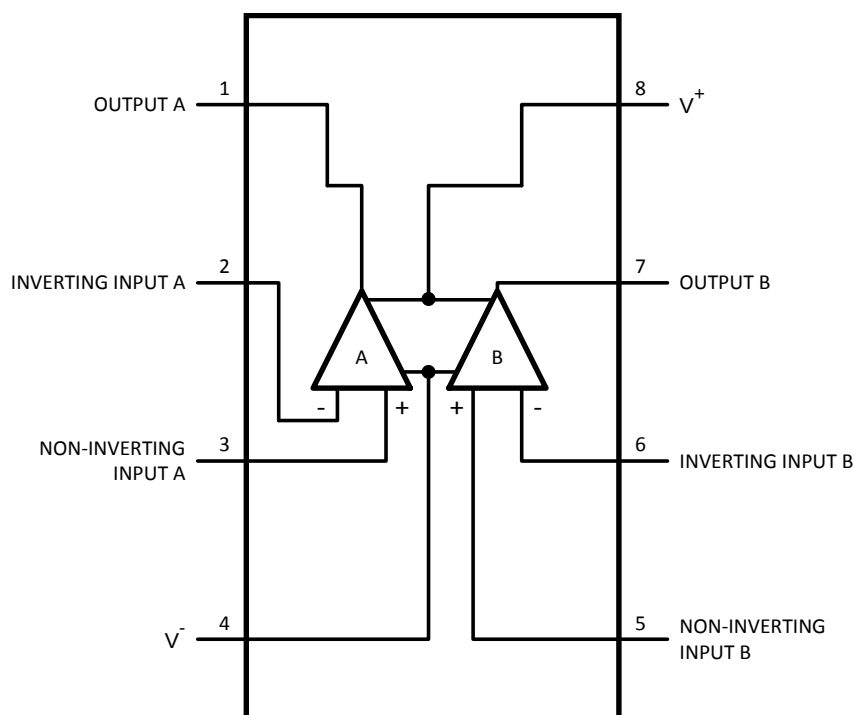
Typical Application



$$f_{\text{MAX}} = > 300 \text{ kHz for } V_{\text{P-P}} = 20\text{V, } R_2 \text{ C}_2 \approx R_1 \text{ C}_1$$

Figure 1. Wide Bandwidth Low Noise Low Drift Amplifier

Connection Diagram



**Figure 2. 8-Lead SOIC
See D Package**



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings ⁽¹⁾⁽²⁾⁽³⁾

Supply Voltage ($V_S = V_{CC} - V_{EE}$)		38V
Storage Temperature		–65°C to 150°C
Input Voltage		(V–) – 0.7V to (V+) + 0.7V
Output Short Circuit ⁽⁴⁾		Continuous
ESD Susceptibility ⁽⁵⁾		2000V
ESD Susceptibility ⁽⁶⁾		200V
Junction Temperature (T_{JMAX})		150°C
Thermal Resistance	θ_{JA}	154°C/W
	θ_{JC}	27°C/W

- (1) “*Absolute Maximum Ratings*” indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the *Absolute Maximum Ratings* or other conditions beyond those indicated in the *Recommended Operating Conditions* is not implied. The *Recommended Operating Conditions* indicate conditions at which the device is functional and the device should not be operated beyond such conditions. All voltages are measured with respect to the ground pin, unless otherwise specified.
- (2) The *Electrical Characteristics* tables list specifications under the listed *Recommended Operating Conditions* except as otherwise modified or specified by the *Electrical Characteristics Conditions* and/or Notes. Typical specifications are estimations only and are not ensured.
- (3) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.
- (4) The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{JMAX} , θ_{JA} , and the ambient temperature, T_A . The maximum allowable power dissipation is $P_{DMAX} = (T_{JMAX} - T_A) / \theta_{JA}$ or the number given in *Absolute Maximum Ratings*, whichever is lower. For the LME49722, $T_{JMAX} = 150^\circ\text{C}$ and the typical θ_{JC} is 27°C/W.
- (5) Human body model, applicable std. JESD22-A114C.
- (6) Machine model, applicable std. JESD22-A115-A.

Operating Ratings

Temperature Range	$T_{MIN} \leq T_A \leq T_{MAX}$	–40°C ≤ T_A ≤ 85°C
Supply Voltage Range		±2.5V ≤ V_S ≤ ±18V

Electrical Characteristics for the LME49722 ⁽¹⁾⁽²⁾

The following specifications apply for $V_S = \pm 15V$ and $\pm 18V$, $R_L = 2k\Omega$, $f_{IN} = 1kHz$ unless otherwise specified. Limits apply for $T_A = 25^\circ C$,

Symbol	Parameter	Conditions	LME49722		Units (Limits)
			Typical ⁽³⁾	Limit ⁽⁴⁾	
THD+N	Total Harmonic Distortion + Noise	$A_V = 1$, $V_{OUT} = 3V_{rms}$ $R_L = 2k\Omega$ $R_L = 600\Omega$	0.00002 0.00002	0.00009	% % (max)
IMD	Intermodulation Distortion	$A_V = 1$, $V_{OUT} = 3V_{RMS}$ Two-tone, 60Hz & 7kHz 4:1	0.00002		%
GBWP	Gain Bandwidth Product	$f_{IN} = 100kHz$	55	45	MHz (min)
SR	Slew Rate	$A_V = 1$, $V_{OUT} = 10V_{P-P}$	± 22	± 15	V/ μs (min)
FPBW	Full Power Bandwidth	$V_{OUT} = 1V_{P-P}$, $-3dB$ referenced to output magnitude at $f = 1kHz$	12		MHz
t_s	Settling time	$A_V = -1$, 10V step, $C_L = 100pF$ 0.1% error range	1.2		μs
e_{INV}	Equivalent Input Voltage Noise	$f_{BW} = 20Hz$ to $20kHz$	0.25	0.35	μV_{RMS} (max)
e_N	Equivalent Input Voltage Density	$f = 1kHz$ $V_S = \pm 15V$ $V_S = \pm 18V$	1.9 1.9	2.5	$nV/\sqrt{Hz}$ $nV/\sqrt{Hz}$ (max)
		$f = 10Hz$ $V_S = \pm 15V$ $V_S = \pm 18V$	2.8 3.2		$nV/\sqrt{Hz}$ $nV/\sqrt{Hz}$
I_n	Current Noise Density	$f = 1kHz$ $f = 10Hz$	2.6 6		$pA/\sqrt{Hz}$ $pA/\sqrt{Hz}$
V_{OS}	Offset Voltage	$V_{CM} = 0V$	± 0.02	± 0.7	mV (max)
PSRR	Power Supply Rejection Ratio	$\Delta V_S = 20V^{(5)}$	120	110	dB (min)
ISO _{CH-CH}	Channel-to-Channel Isolation	$f_{IN} = 1kHz$ $f_{IN} = 20kHz$	136 135		dB dB
I_B	Input Bias Current	$V_{CM} = 0V$ $V_S = \pm 15V$ $V_S = \pm 18V$	50 53	200	nA nA (max)
$\Delta I_{OS}/\Delta T_{emp}$	Input Bias Current Drift vs Temperature	$-40^\circ C \leq T_A \leq 85^\circ C$	0.1		nA/ $^\circ C$
I_{OS}	Input Offset Current	$V_{CM} = 0V$ $V_S = \pm 15V$ $V_S = \pm 18V$	25 32	100	nA nA (max)
V_{IN-CM}	Common-Mode Input Voltage Range	$V_S = \pm 15V$	+14.0 -13.9	$(V_{CC}) - 2.0$ $(V_{EE}) + 2.0$	V (min) V (min)
		$V_S = \pm 18V$	+17.0 -16.9	$(V_{CC}) - 2.0$ $(V_{EE}) + 2.0$	V (min) V (min)
CMRR	Common-Mode Rejection	$-10V \leq V_{CM} \leq 10V$	128	110	dB (min)
Z_{IN}	Differential Input Impedance		30		k Ω
Z_{CM}	Common Mode Input Impedance	$-10V \leq V_{CM} \leq 10V$	1000		M Ω
A_{VOL}	Open Loop Voltage Gain	$-12V \leq V_{OUT} \leq 12V$, $R_L = 600\Omega$	135	120	dB
		$-12V \leq V_{OUT} \leq 12V$, $R_L = 2k\Omega$	140		dB
		$-12V \leq V_{OUT} \leq 12V$, $R_L = 10k\Omega$	140		dB

- (1) "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the *Absolute Maximum Ratings* or other conditions beyond those indicated in the *Recommended Operating Conditions* is not implied. The *Recommended Operating Conditions* indicate conditions at which the device is functional and the device should not be operated beyond such conditions. All voltages are measured with respect to the ground pin, unless otherwise specified.
- (2) The *Electrical Characteristics* tables list specifications under the listed *Recommended Operating Conditions* except as otherwise modified or specified by the *Electrical Characteristics Conditions* and/or Notes. Typical specifications are estimations only and are not ensured.
- (3) Typical values represent most likely parametric norms at $T_A = +25^\circ C$, and at the *Recommended Operation Conditions* at the time of product characterization and are not ensured.
- (4) Datasheet min/max specification limits are specified by test or statistical analysis.
- (5) PSRR is measured as follow: V_{OS} is measured at two supply voltages, $\pm 5V$ and $\pm 15V$. $PSRR = |20\log(\Delta V_{OS}/\Delta V_S)|$.

Electrical Characteristics for the LME49722 ⁽¹⁾⁽²⁾ (continued)

The following specifications apply for $V_S = \pm 15V$ and $\pm 18V$, $R_L = 2k\Omega$, $f_{IN} = 1kHz$ unless otherwise specified. Limits apply for $T_A = 25^\circ C$,

Symbol	Parameter	Conditions	LME49722		Units (Limits)
			Typical ⁽³⁾	Limit ⁽⁴⁾	
V_{OM}	Output Voltage Swing	$V_S = \pm 15V$ $R_L = 600\Omega$ $R_L = 2k\Omega$ $R_L = 10k\Omega$	$+13.7/-14$ ± 14.0 ± 14.1		V_{PEAK} V_{PEAK} V_{PEAK}
		$V_S = \pm 18V$ $R_L = 600\Omega$ $R_L = 2k\Omega$ $R_L = 10k\Omega$	$+16.6/-16.8$ ± 17.0 ± 17.1	± 15.5	$V_{PEAK} (min)$ V_{PEAK} V_{PEAK}
I_{OUT}	Output Current	$R_L = 600\Omega$ $V_S = \pm 15V$ $V_S = \pm 18V$	± 23 $\pm 27.6/-28$	± 23	mA mA (min)
I_{OUT-CC}	Short Circuit Current	Sink to Source	$+43$ -40		mA mA
Z_{OUT}	Output Impedance	$f_{IN} = 10kHz$ Closed-Loop Open-Loop	0.01 13		Ω Ω
I_S	Total Quiescent Power Supply Current	$I_{OUT} = 0mA$ $V_S = \pm 15V$ $V_S = \pm 18V$	12.1 12.3	16	mA mA (max)

Typical Performance Characteristics

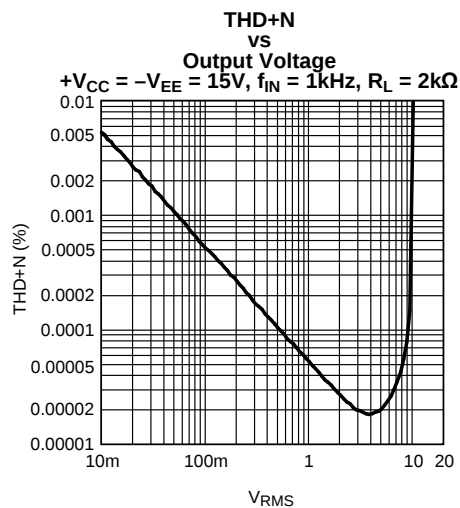


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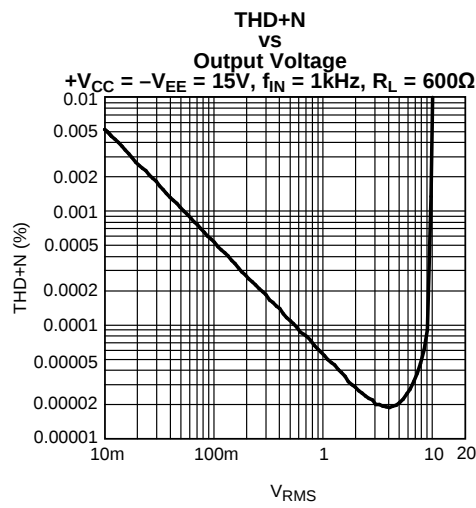


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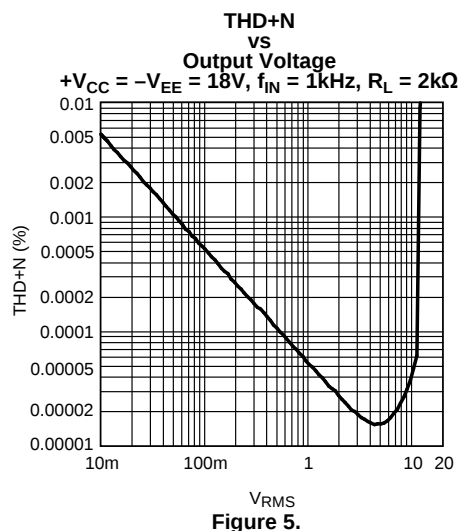


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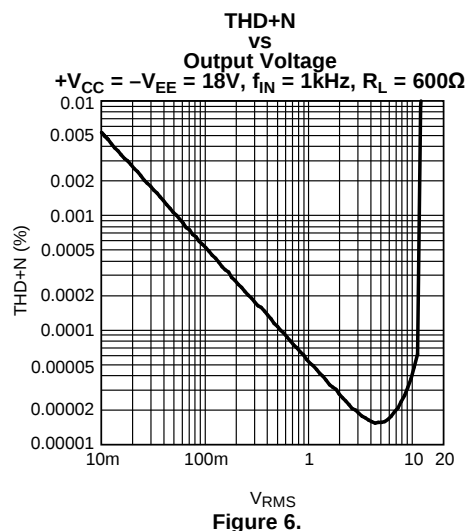


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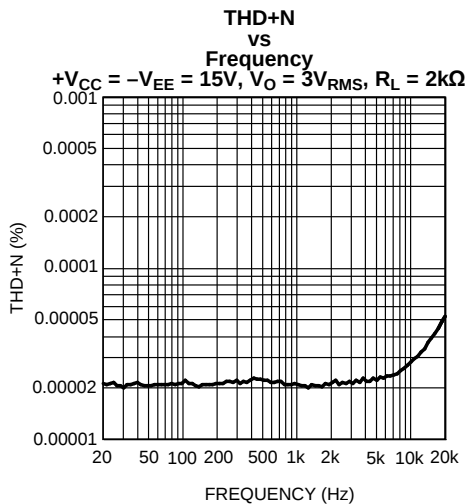


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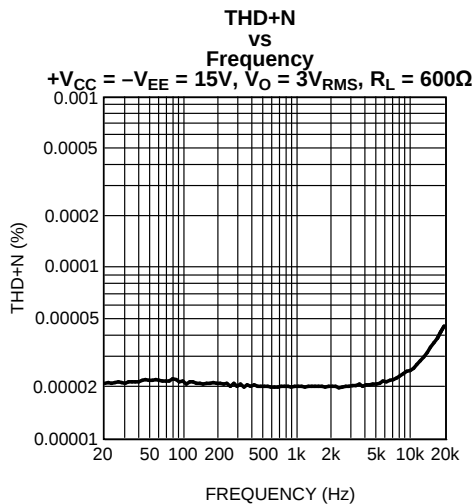


Figure 8.

Typical Performance Characteristics (continued)

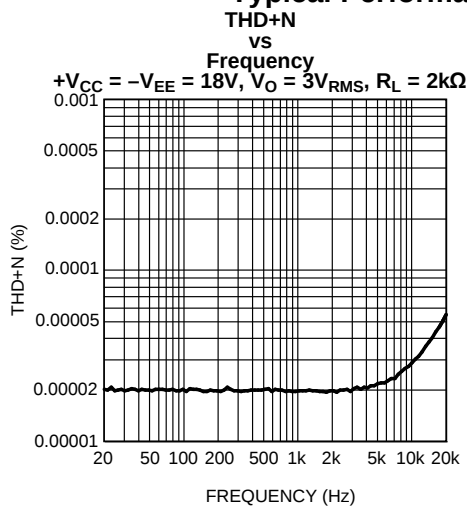


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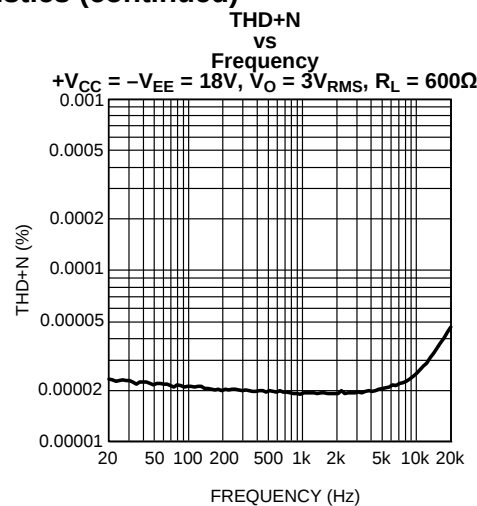


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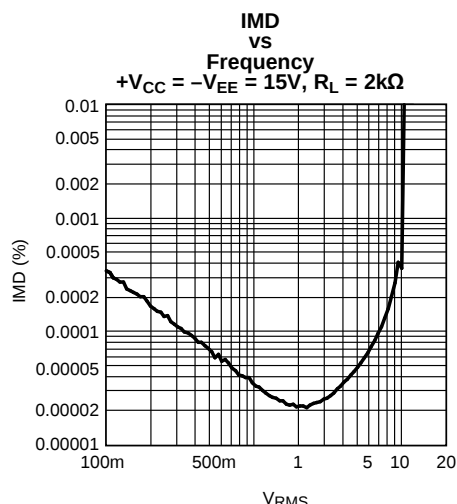


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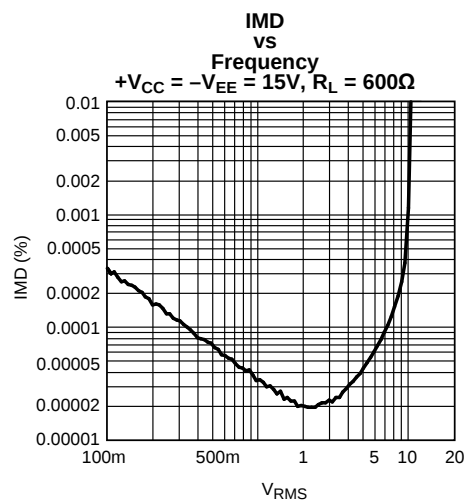


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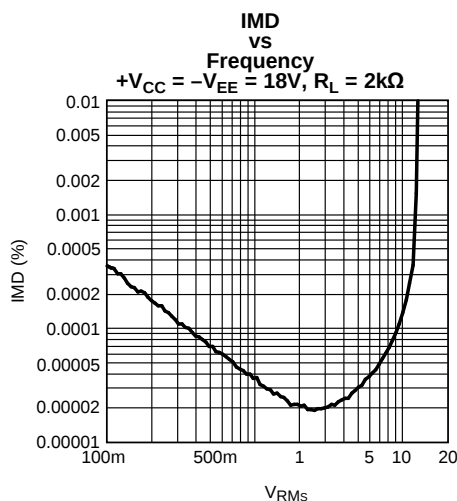


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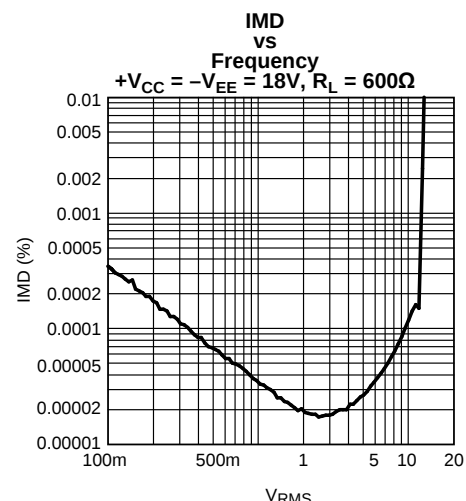


Figure 14.

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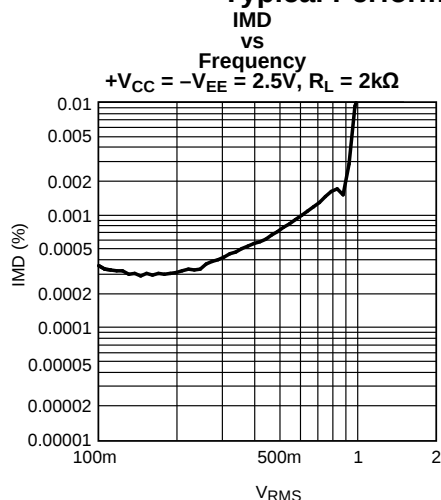


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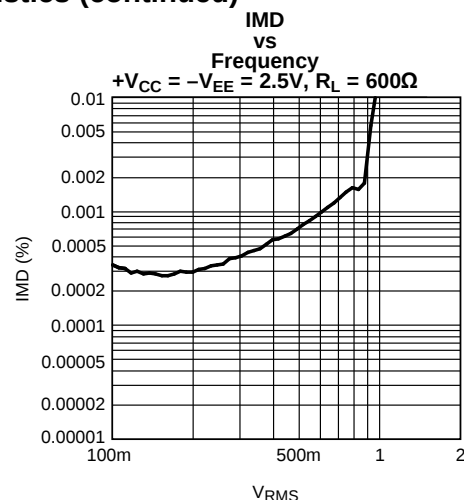


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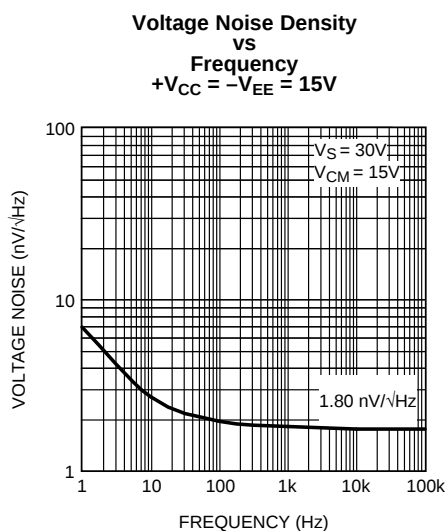


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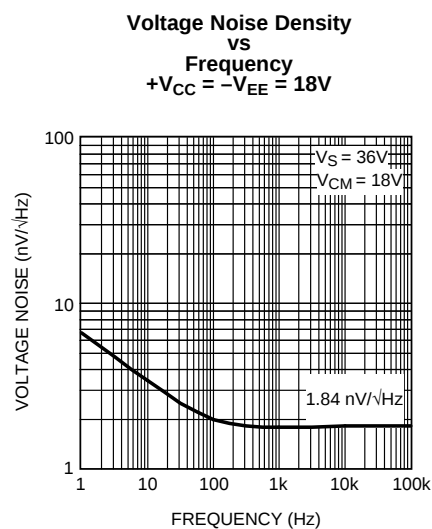


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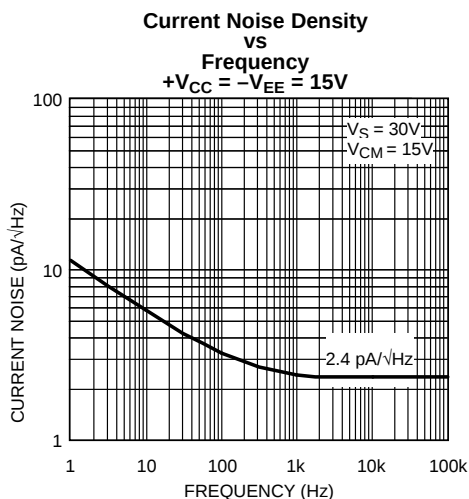


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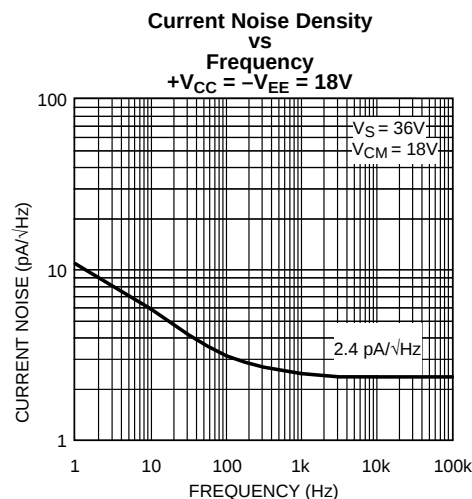


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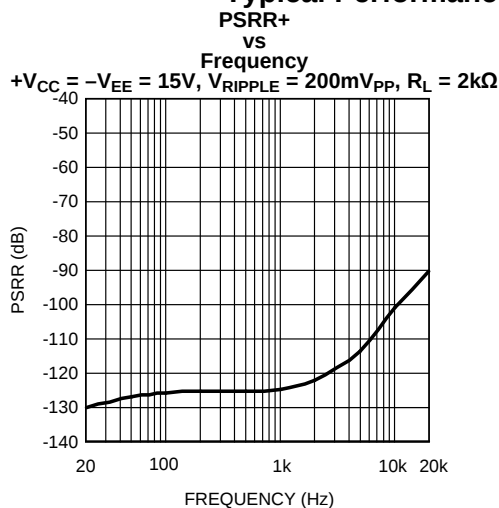


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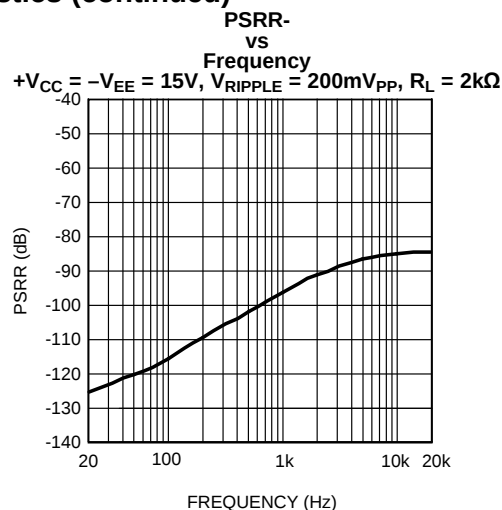


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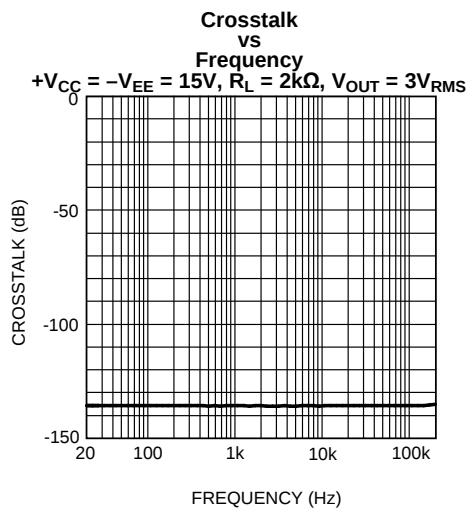


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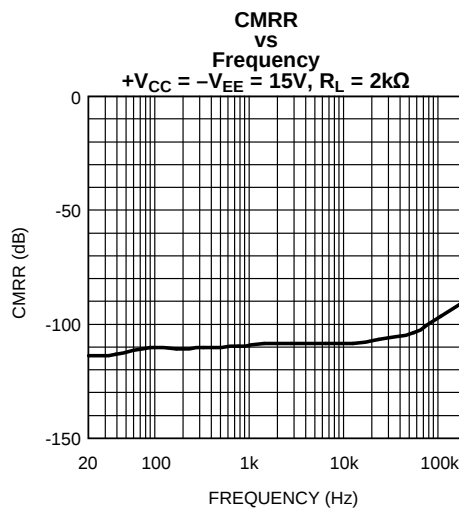


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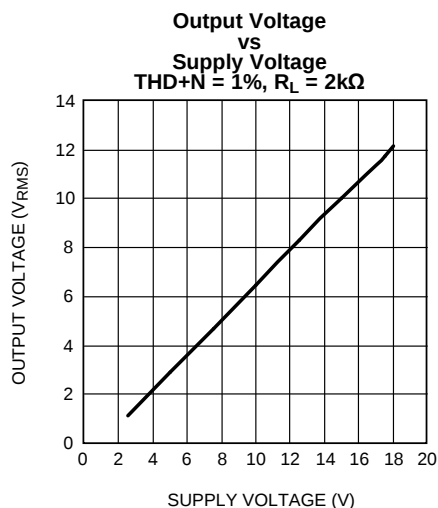


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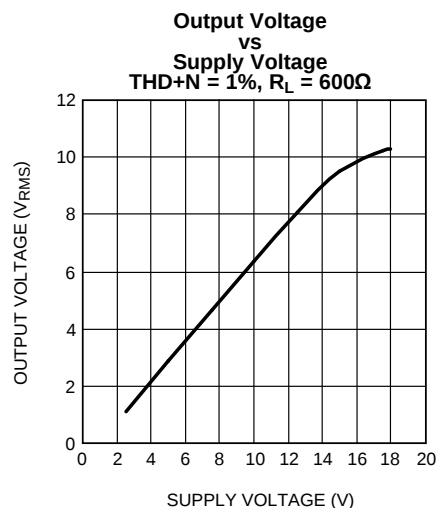


Figure 26.

Typical Performance Characteristics (continued)

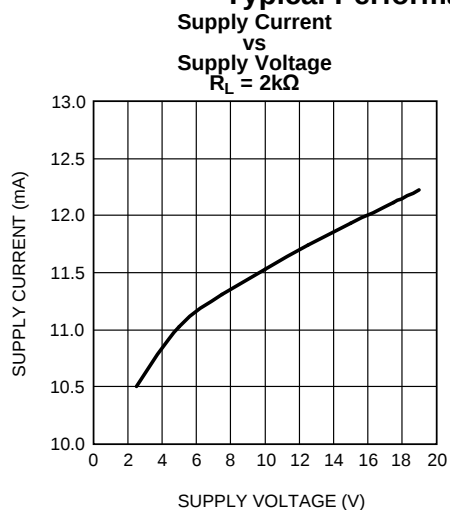


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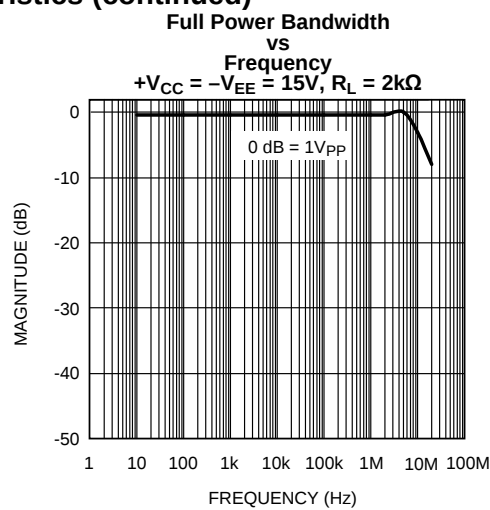


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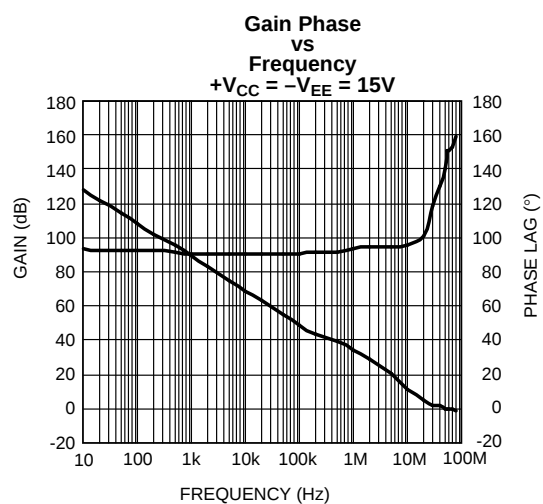
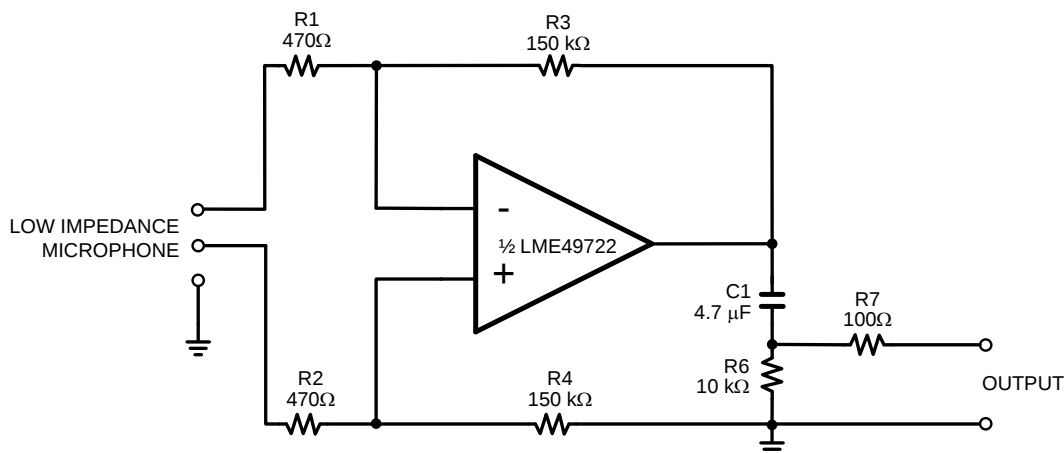


Figure 29.

APPLICATION INFORMATION

APPLICATION HINTS

The LME49722 is a high speed operational amplifier which can operate stably in most of the applications. For the application with gain greater than 2, capacitive loads up to 100pF will cause little change in the phase characteristics of the amplifiers and are therefore allowable. Capacitive loads greater than 10pF must be isolated from the output, if the gain value is less than 2. The most straightforward way to do this is to put a resistor (its value $\geq 20\Omega$) in series with the output. The resistor will also prevent unnecessary power dissipation if the output is accidentally shorted.



- Total voltage noise density: $e_{N_total}^2 \approx e_N^2 + e_{N_R1}^2 + e_{N_R2}^2 = 1.9^2 + 2(2.7^2)$,
then $e_{N_total} = 4.3 \text{ nV}/\sqrt{\text{Hz}}$. For $e_{N_R1} = e_{N_R2} \approx 2.7 \text{ nV}/\sqrt{\text{Hz}}$, if $R1 = R2 \approx 470\Omega$.
- Or total voltage noise = $0.13 \mu\text{V}$ input referred in a 1 kHz noise bandwidth.

Figure 30. Low Impedance Microphone Pre-amplifier

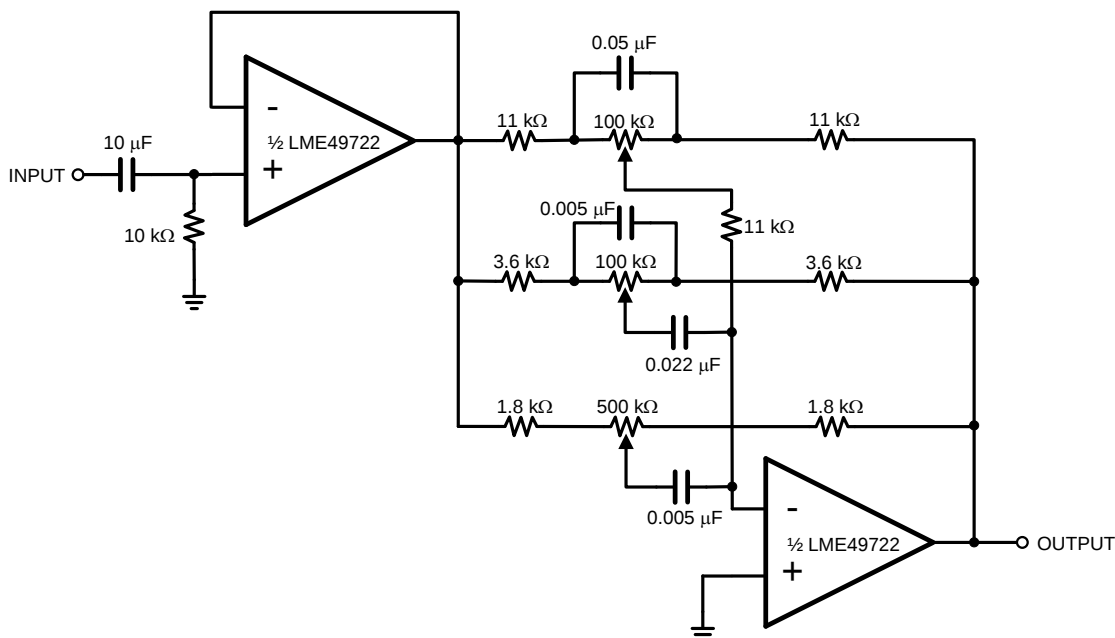


Figure 31. Three-Band Active Tone Control

REVISION HISTORY

Rev	Date	Description
1.0	03/27/08	Initial release.
A	04/04/13	Changed layout of National Data Sheet to TI format.

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